



650V, 70A,  $V_{CE(on)}$ = 1.9V Typical

## Ultra Fast NPT - IGBT®

The Ultra Fast 650V NPT-IGBT® family of products is the newest generation of IGBTs optimized for outstanding ruggedness and best trade-off between conduction and switching losses.

### **Features**

- · Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- Short Circuit Withstand Rated
- High Frequency Switching
- Low Leakage Current



Combi (IGBT and Diode)



Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

### **MAXIMUM RATINGS**

All Ratings: I	$_{\rm C}$ = 25°C (	uniess otnerwi	se specified.

Symbol	Parameter	Ratings	Unit
V <sub>ces</sub>	Collector Emitter Voltage	650	V
$V_{\rm GE}$	Gate-Emitter Voltage	±30	ľ
I <sub>C1</sub>	Continuous Collector Current @ T <sub>C</sub> = 25°C	134	
I <sub>C2</sub>	Continuous Collector Current @ T <sub>C</sub> = 110°C	65	Α
I <sub>CM</sub>	Pulsed Collector Current ①	260	
SCWT	Short Circuit Withstand Time: V <sub>CE</sub> = 600V, V <sub>GE</sub> = 15V, T <sub>C</sub> =125°C	10	μs
P <sub>D</sub>	Total Power Dissipation @ T <sub>c</sub> = 25°C	595	W
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C
T <sub>L</sub>	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage $(V_{GE} = 0V, I_{C} = 250uA)$	650			
V <sub>GE(TH)</sub>	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 1.0 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$	3.5	5.0	6.5	\
.,	Collector-Emitter On Voltage (V <sub>GE</sub> = 15V, I <sub>C</sub> = 70A, T <sub>j</sub> = 25°C)	ĺ	1.9	2.4	Volts
V <sub>CE(ON)</sub>	Collector-Emitter On Voltage ( $V_{GE} = 15V$ , $I_{C} = 70A$ , $T_{j} = 125$ °C)		2.4		
	Collector-Emitter On Voltage ( $V_{GE} = 15V$ , $I_{C} = 140A$ , $T_{j} = 25^{\circ}C$ )		2.6		
I <sub>ces</sub>	Collector Cut-off Current (V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 25°C) ②		40	850	μΑ
CL3	Collector Cut-off Current (V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 125°C) ②		500		
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>GE</sub> = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C <sub>ies</sub>	Input Capacitance	Capacitance		4250		
C <sub>oes</sub>	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		847		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz		415		
$V_{\sf GEP}$	Gate to Emitter Plateau Voltage	Gate Charge		7.0		V
Q <sup>3</sup>	Total Gate Charge	V <sub>GE</sub> = 15V		226	305	
$Q_{ge}$	Gate-Emitter Charge	V <sub>CE</sub> = 325V		26	35	nC
$Q_{gc}$	Gate- Collector Charge	I <sub>C</sub> = 70A		104	140	
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (25°C)		19		
t,	Current Rise Time	V <sub>CC</sub> = 433V		45		20
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		170		ns
t <sub>f</sub>	Current Fall Time	I <sub>C</sub> = 70A		67		
E <sub>on2</sub> ⑤	Turn-On Switching Energy	$R_{\rm G} = 4.3\Omega^{(4)}$		1790	2685	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +25°C		1460	1970	μJ
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (125°C)		19		
t <sub>r</sub>	Current Rise Time	V <sub>CC</sub> = 433V		45		20
$t_{d(off)}$	Turn-Off Delay Time	V <sub>GE</sub> = 15V		190		ns
t <sub>f</sub>	Current Fall Time	I <sub>C</sub> = 70A		74		
E <sub>on2</sub> 5	Turn-On Switching Energy	$R_{_{\rm G}} = 4.3\Omega^{\oplus}$		1760	2640	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +125°C		1720	2580	μJ

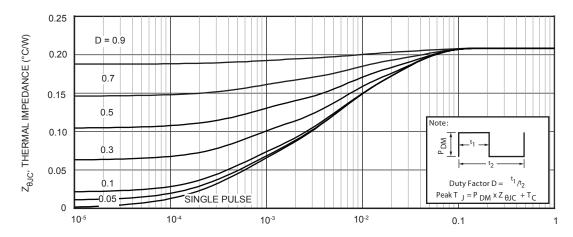
#### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction to Case Thermal Resistance			.21 40 °C/W	
$R_{\theta JA}$	Junction to Ambient Thermal Resistance				
10/	Package Weight		.22		oz
$W_{T}$	Package Weight		6.2		g

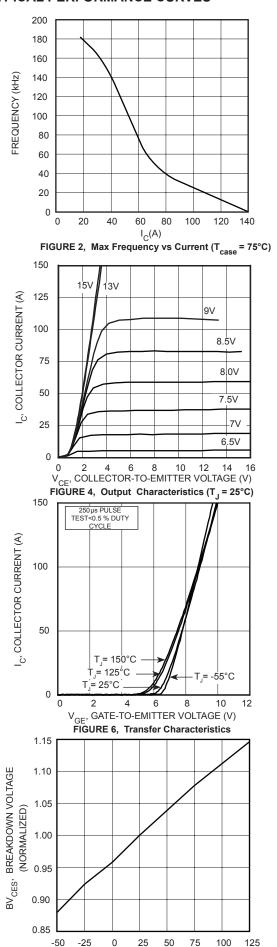
- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width < 380 $\mu$ s, duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- $4~~R_{_{\mathrm{G}}}$  is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5  $E_{on2}$  is the energy loss at turn-on and includes the charge stored in the freewheeling diode.

onz
6 E<sub>off</sub> is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

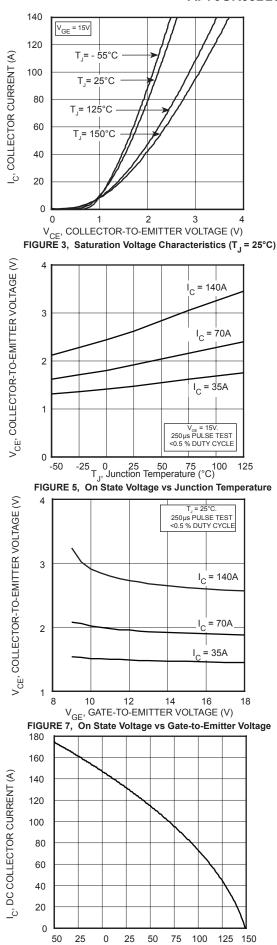


RECTANGULAR PULSE DURATION (SECONDS) Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration



 $T_{\rm J}$ , JUNCTION TEMPERATURE

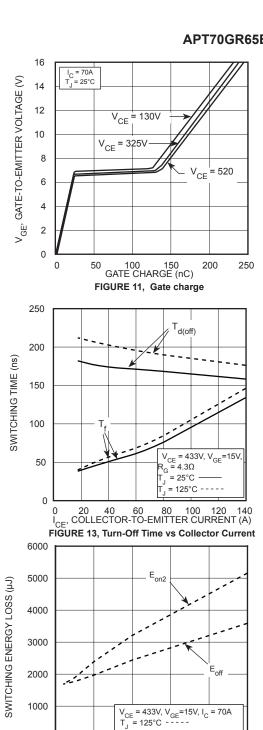
FIGURE 8, Breakdown Voltage vs Junction Temperature



T<sub>C</sub>, Case Temperature (°C)

FIGURE 9, DC Collector Current vs Case Temperature

FIGURE 16, Swiitching Energy vs Junction Temperature



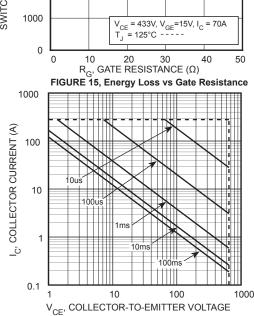


FIGURE 17, Minimum Switching Safe Operating Area

# ZERO RECOVERY LOW LEAKAGE SIC ANTI-PARALLEL DIODE

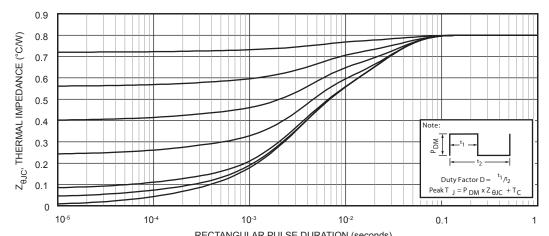
### **MAXIMUM RATINGS**

All Ratings:	T_ =	25°C unless	otherwise	specified.

Symbol	Symbol Characteristic / Test Conditions		Ratings	Unit
I <sub>F</sub> Maximum D.C. Forward Current	T <sub>C</sub> = 25°C	46		
	T <sub>c</sub> = 85°C	30	Amps	
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current (T <sub>J</sub> = 25°C, t <sub>p</sub> = 10ms, Half Sine)		247	·

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit
.,	Forward Voltage		1.5		Volts	
V <sub>F</sub>			1.9			
Q <sub>c</sub>	Total Capactive Charge $V_R$ = 325V, $I_F$ = 30A, di/dt = -500A/ $\mu$ s, $T_J$ = 25°C			150		nC
	Junction Capacitance $V_R = 1V$ , $T_J = 25$ °C, $f = 1MHz$			945		
C <sub>T</sub>	C <sub>T</sub> Junction Capacitance V <sub>R</sub> = 200V, T <sub>J</sub> = 25°C, f = 1MHz			138		pF
	Junction Capacitance V <sub>R</sub> = 400V, T <sub>J</sub> = 25°C, f = 1MHz			105		



RECTANGULAR PULSE DURATION (seconds)
FIGURE 18. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION

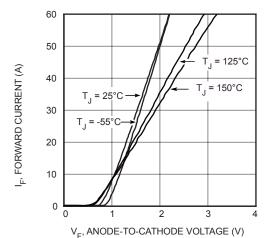


FIGURE 19, Forward Current vs. Forward Voltage

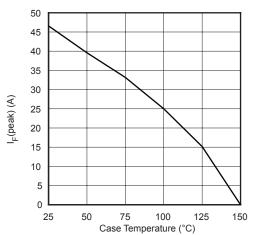


FIGURE 20, Maximum Forward Current vs. Case Temperature

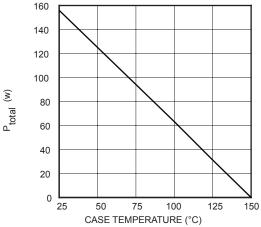
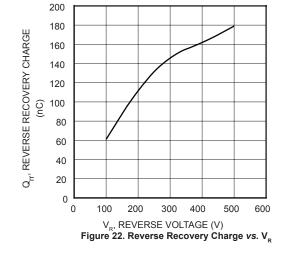
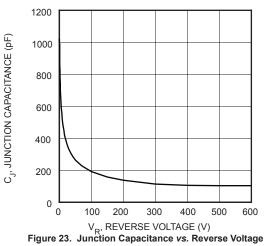
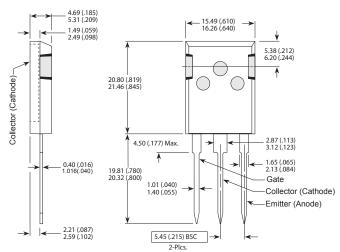


Figure 21. Maximum Power Dissipation vs. Case Temperature





## T-MAX® (B2) Package Outline



These dimensions are equal to the TO-247 without the mounting hole. Dimensions in Millimeters and (Inches)

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